

承認書

SPECIFICATION FOR APPROVAL

CUSTOMER:_____

DESCRIPTION:_____ WIRE WOUND CHIP INDUCTOR _____

PART NO:_____

CUSTOMERMODELNO:_____ DHWI0805QD系列 _____

DRAWING		
MADE	CHECKED	APPROVE
吴梦	任霞	廖文磊
DATE:	2022年11月5日	

CUSTOMER APPROVE

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PART NO:		SN.	
CUSTOMER NO:	DHWI0805QD系列	DATE:	2022年11月5日

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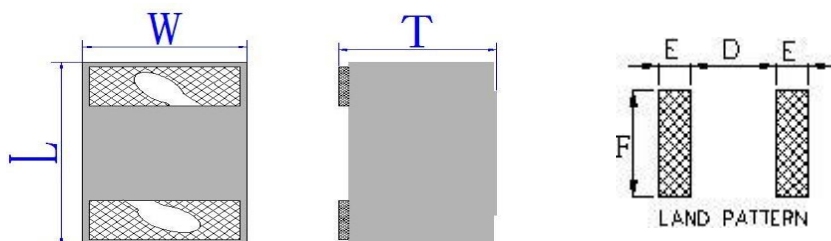
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1.SHAPE & DIMENSION



CODE		L(Max)	W(Max)	T(Max)	E(Typ.)	F(Typ.)	D(Typ.)
DIMENSION	DHWI0805QD	2.40	1.73	1.52	1.02	1.78	0.76

2. PART NUMBERING SYSTEM

DHWI 0805 QD 2R2 M S T - HF
1 2 3 4 5 6 7 8

- PRODUCT SYMBOL (产品代号)
- DIMENSIONS (规格尺寸)
- MATERIAL (芯片类型)
- INDUCTANCE (电感量)
- TOLERANCE (公差) : K $\pm$ 10%; M $\pm$ 20%
- TERMINAL (端电极材料) : S-锡端头
- PACKAGING (包装方式) : T-编带盘装; B-散装
- E.P. (环保) : LF—Lead Free HF—Halogen Free FP—Red Phosphor Free

3.GENERAL SPECIFICATION

- Rating DC current: Temperature rise(ΔT) is 40°C approximately at Irms.
- Operating temp.: -40°C~+85°C
- Storage temp.: -10°C ~ +40°C R.H.: 65% Max
- Moisture sensitivity level (MSL) 2 (1 year floor life at <30°C/65% relative humidity)

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4. Electrical Characteristics List

[illegible]

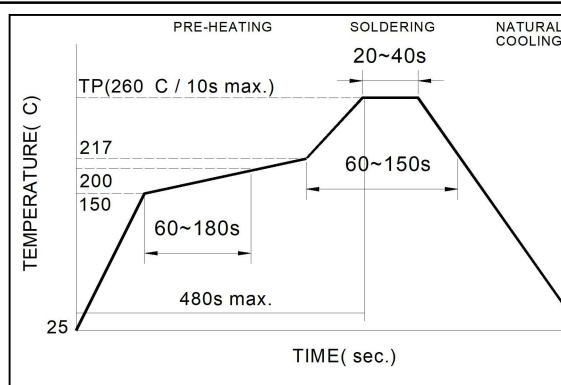
产品公差: $K \pm 10\%$; $M \pm 20\%$

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5. SOLDERING CONDITIONS

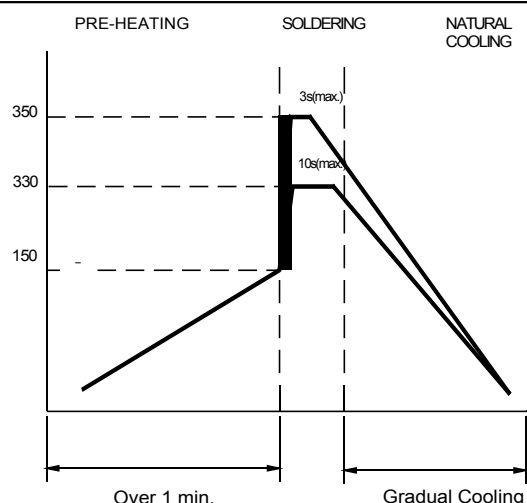
**Figure 1.
Re-flow
Soldering
(Lead Free)**



Note:

- Preheat circuit and products to 150°C
- 260°C tip temperature (max)
- Reflow times: no more than 2 times
- Solder paste thickness: the best 0.08mm is ,but max is 0.1mm

**Figure 2.
Hand
Soldering**



Note:

- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 sec.

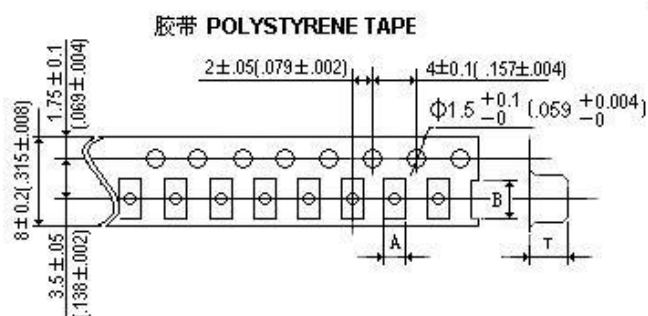
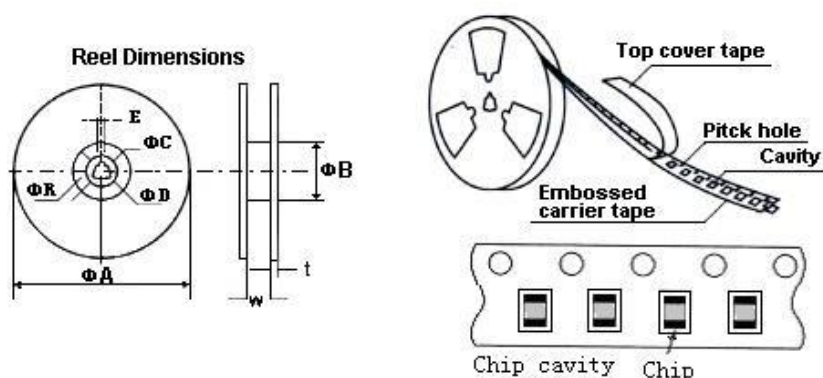
6.APPEARANCE STANDARD

Appearance Defect	Graphic	Judging Standard
Copper wire exposed		Area of copper wire exposed in magnetic shield area less than 0.06 square millimeter is OK.

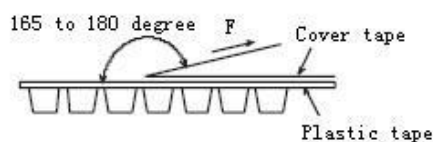
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7. PACKAGING(unit: mm)



Peeling off force
 Pull strength
 0402~1210:20g~80g
 Speed of peeling off:
 300mm/min±10%



胶带		A	B	T
	0805	1.85	2.4	1.45

Type	ΦA	ΦB	ΦC	ΦD	E	W	t	R
0805	178	60	13	21	2	8.4	2	1

包装数量(PACKAGING QUANTITY): 2000Pcs/盘

注意:

此物料不涉及汽车或相关产品方面的应用, 否则, 由此引起的一切品质和责任问题, 我司将概不承担。